

SEA & LAND ELECTRONIC CORP.

www.sealand-pptc.com

ALPHA-TOP TECHNOLOGY CORP.

www.alpha-top.cn

APPROVAL SHEET

MODEL NO.:	SMD2018-075
CUSTOMER:	
CUSTOMER'S APPROVA	L:
AUTHORIZED SIGNATUR	RE/STAMP:
DATE	

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Approved by: YC Lin
DATE: 7-Jun-23

SEA & LAND ELECTRONIC CORP.



SMD2018-075

Features

- Surface Mount Devices
- Lead free device
- Size 4.5*3.2 mm/0.18*0.12 inch
- Surface Mount packaging for automated assembly

Applications

Almost anywhere there is a low voltage power supply, up to 60V and a load to be

protected, including:

- Computer mother board, Modem. USB hub
- PDAs & Charger, Analog & digital line card
- Digital cameras, Disk drivers, CD-ROMs,

Alpha-Top (Sea & Land Alliance)

Performance Specification

Madal	V_{max}	I _{max}	I _{hold}	I _{trip}	P_d		mum Го Trip	Resistance Agency Approv			Approval
Model			@25°C		Max.	Current	Time	Ri _{min}	R1max	UL	TUV
	(Vdc)	(A)	(A)	(A)	(W)	(A)	(Sec)	(Ω)	(Ω)	OL.	101
SMD2018-075	33	100	0.75	1.50	1.1	8.0	0.50	0.130	0.900		

Ihold = Hold Current. Maximum current device will not trip in 25°C still air.

Itrip = Trip Current. Minimum current at which the device will always trip in 25°C still air.

Vmax = Maximum operating voltage device can withstand without damage at rated current (Imax).

Imax = Maximum fault current device can withstand without damage at rated voltage (Vmax).

Pd = Power dissipation when device is in the tripped state in 25°C still air environment at rated voltage.

Rimin/max = Minimum/Maximum device resistance prior to tripping at 25°C.

R1_{max} = Maximum device resistance is measured one hour post reflow.

CAUTION: Operation beyond the specified ratings may result in damage and possible arcing and flame.

Environmental Specifications

Test	Conditions					
Passive aging	+85°C, 1000 hrs.					
Humidity aging	+85°C, 85% R.H., 168 hours					
Thermal shock	+85°C to -40°C, 20 times					
Resistance to solvent	MIL-STD-202,Method 215					
Vibration	MIL-STD-202,Method 201					
Ambient operating conditions : - 40 °C to +85 °C						
Maximum surface temperature of the device in the tripped state is 125 °C						
In case of special use, please contact our engineer						

Agency Approvals :

Regulation/Standard:

Pto RoHS

2015/863/EU

HF

EN14582

I_{hold} Versus Temperature

	Model	lodel Maximum ambient operating temperature (T_{mao}) vs. hold current (I_{hold})								
Н		-40°C	-20°C	0°C	25°C	40°C	50°C	60°C	70°C	85°C
	SMD2018-075	1.13	1.02	0.88	0.75	0.59	0.52	0.43	0.37	0.25



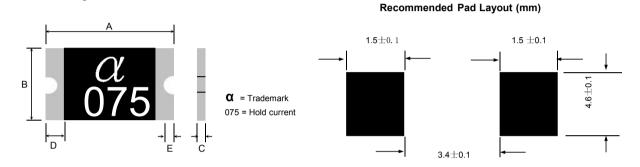
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Alpha-Top (Sea & Land Alliance)

Construction And Dimension (Unit:mm)

Model		A		В		C	D	Е
Model	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Min.
SMD2018-075	4.72	5.44	4.22	4.93	0.60	1.00	0.30	0.30

Dimensions & Marking



Termination Pad Characteristics

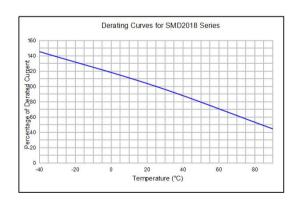
Terminal pad materials : Tin-plated Nickel-Copper

Terminal pad solderability: Meets EIA specification RS186-9E and ANSI/J-STD-002 Category 3.

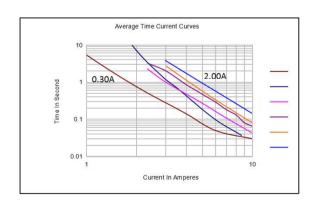
Rework

Use standard industry practices, the removal device must be replaced with a fresh one.

Thermal Derating Curve



Typical Time-To-Trip At 25°C



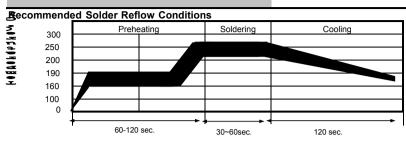
WARNING:

- Use PPTC beyond the maximum ratings or improper use may result in device damage and possible electrical arcing and flame.
 PPTC are intended for protection against occasional over current or over temperature fault conditions and should not be used when repeated fault conditions or prolonged trip events are
- · Device performance can be impacted negatively if devices are handled in a manner inconsistent with recommended electronic, thermal, and mechanical procedures for electronic components.

 · Use PPTC with a large inductance in circuit will generate a circuit voltage (L di/dt) above the rated voltage of the PPTC.
- Avoid impact PPTC device its thermal expansion like placed under pressure or installed in limited space.
- Contamination of the PPTC material with certain silicon based oils or some aggressive solvents can adversely impact the performance of the devices. PPTC SMD can be cleaned by standard methods.



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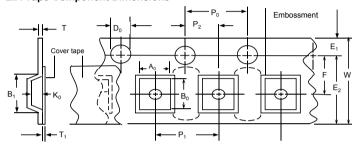
- · Recommended reflow methods : IR, vapor phase oven, hot air oven.
- Devices are not designed to be wave soldered to the bottom side of the board.
- · Recommended maximum paste thickness is 0.25 mm (0.010 inch).
- Devices can be cleaned using standard method and solvents.

Note: If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

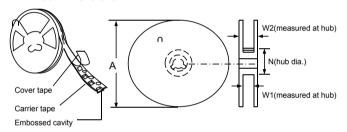
Tape And Reel Specifications (mm)

Governing Specifications	EIA 481-2
W	12.0 ± 0.20
P ₀	4.0 ± 0.10
P ₁	8.0 ± 0.10
P ₂	2.0 ± 0.05
A ₀	4.40 ± 0.10
B_0	5.50 ± 0.10
B₁max.	8.2
D_0	1.5 + 0.1, -0.0
F	5.5 ± 0.05
E ₁	1.75 ± 0.10
E ₂ min.	10.25
Tmax.	0.6
T₁max.	0.1
_K ₀	1.36 ± 0.1
Leader min.	390
Trailer min.	160
Reel Dimensions	
A max.	178
N min.	50
W ₁	12.4 + 2.0, -0.0
W ₂ max.	18.4
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EIA Tape Component Dimensions



EIA Reel Dimensions



Storage And Handling

- Storage conditions : 40°C max, 70% R.H.
- Devices may not meet specified performance if storage conditions are exceeded.

Order Information Packaging

	. wegg				
SMD2018	075	Tape & Reel Quantity			
Product name	Hold				
Size 5045mm/2018 inch	Current	2500 pcs/reel			
SMD : surface mount device	0.75A				

Tape & reel packaging per EIA481-1

Labeling Information

